

MODEL ATM-12000DR

Automatic Wafer Mounter(with Detape function)

Outline

The ATM-12000RM is ideal system for mounting 8", 12" wafers to dicing frame and then removing protective tape.

Features

- Capable of handling 12" 150 μ thickness wafer and aligning precisely.
- Vacuum chamber application eliminates air bubbles and less damage wafers.
- Removing without any stress to wafer by unique method.



Specification		ATM-12000DR
Throughput		40 wafers/h(Depend on data setting
Wafer Size		8 inch, 12 inch
Frame Size		2 8 1,212 1
Tape Width		8 inch:W 300mm 12 inch:W 400mm(Removal tape width:50mm)
Utilities	Power	AC200V 3phase 50 / 60Hz 5.0KVA
	Air	Pressure 0.5Mpa 200NI/min
	Vacuum source	Using venturi valve
Dimensions		D 2,800 × W 1,800 × H 1,800mm
Weight		2000kg

System appearance and specifications are subject to change without prior notice from the supplier.

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